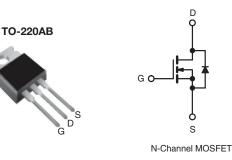


## Power MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	100				
R <sub>DS(on)</sub> (Ω)	$V_{GS} = 5.0 V$	0.16			
Q <sub>g</sub> (Max.) (nC)	28				
Q <sub>gs</sub> (nC)	3.8				
Q <sub>gd</sub> (nC)	14				
Configuration	Single				



### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Logic-Level Gate Drive
- $R_{DS(on)}$  Specified at  $V_{GS} = 4 V$  and 5 V
- 175 °C Operating Temperature
- · Fast Switching
- · Ease of Paralleling
- Compliant to RoHS Directive 2002/95/EC

### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRL530PbF
	SiHL530-E3
SnPb	IRL530
	SiHL530

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	100	N	
Gate-Source Voltage			V <sub>GS</sub>	± 10	V	
Continuous Drain Current	V at 5.0.V	T <sub>C</sub> = 25 °C	I <sub>D</sub>	15		
	V <sub>GS</sub> at 5.0 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C		11	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	60		
Linear Derating Factor				0.59	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	290	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	15	А	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	8.8	mJ	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		PD	88	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt 5.5		V/ns	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C		
Soldering Recommendations (Peak Temperature)	for	10 s		300 <sup>d</sup>		
Mounting Torque	6.32 or 1	6-32 or M3 screw		10	lbf ⋅ in	
	0-52 OF WIS SCIEW			1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD}$  = 25 V, starting T<sub>J</sub> = 25 °C, L = 1.9 mH, R<sub>g</sub> = 25  $\Omega$  I<sub>AS</sub> = 15 A (see fig. 12).

c.  $I_{SD} \le 15$  A, dI/dt  $\le 140$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175$  °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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# IRL530, SiHL530

## Vishay Siliconix



THERMAL RESISTANCE RATI	NGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		62					
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50 -			°C/W				
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	- 1.7							
<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$ ,	unless otherv	vise noted)							
PARAMETER	SYMBOL	TEST	CONDITI	ONS	MIN.	TYP.	MAX.	UNIT	
Static									
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	V, I <sub>D</sub> = 2	50 µA	100	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference t	o 25 °C,	I <sub>D</sub> = 1 mA	-	0.14	-	V/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_0$	<sub>GS</sub> , I <sub>D</sub> = 2	50 μA	1.0	-	2.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	Vo	<sub>GS</sub> = ± 10	1	-	-	± 100	nA	
Zene Oete Maltere Dreis Ormert		V <sub>DS</sub> = 10	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V			-	25		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 80 V, V <sub>0</sub>	<sub>GS</sub> = 0 V,	T <sub>J</sub> = 150 °C	-	-	250	μA	
	_	V <sub>GS</sub> = 5.0 V	١	<sub>0</sub> = 9.0 A <sup>b</sup>	-	-	0.16		
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.0 V	ار	<sub>0</sub> = 7.5 A <sup>b</sup>	-	-	0.22	Ω	
Forward Transconductance		$V_{DS} = 50 \text{ V}, \text{ I}_{D} = 9.0 \text{ A}^{b}$			6.4	-	-	S	
Dynamic	I	·			1	<u> </u>		1	
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$		-	930	-	pF		
Output Capacitance	C <sub>oss</sub>			-	250	-			
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 M	MHz, see	fig. 5	-	57	-	1	
Total Gate Charge	Qg			= 15 A, V <sub>DS</sub> = 80 V, see fig. 6 and 13 <sup>b</sup>	-	-	28	nC	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 5.0 V			-	-	3.8		
Gate-Drain Charge	Q <sub>gd</sub>		3001		-	-	14		
Turn-On Delay Time	t <sub>d(on)</sub>				-	4.7	-		
Rise Time	t <sub>r</sub>	- 	0 V I _	15 0	-	100	-	1	
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{DD} = 50$ V, $I_D = 15$ A, R <sub>g</sub> = 12 Ω, R <sub>D</sub> = 32 Ω, see fig. 10 <sup>b</sup>		-	22	-	ns		
Fall Time	t <sub>f</sub>				-	48	-	1	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH		
Internal Source Inductance	L <sub>S</sub>			-	7.5	-			
Drain-Source Body Diode Characteristic	cs								
Continuous Source-Drain Diode Current	ا <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	15	A		
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	60			
Body Diode Voltage	V <sub>SD</sub>	$T_J = 25 \text{ °C}, I_S = 15 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	-	2.5	V		
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = 15 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}^{b}$		-	150	200	ns		
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.93	1.4	μC		
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn			-on is doi	minated b	y L <sub>S</sub> and	L <sub>D</sub> )	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$ 

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## IRL530, SiHL530

### **Vishay Siliconix**

### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

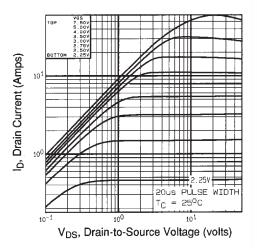


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

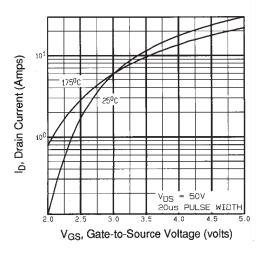


Fig. 3 - Typical Transfer Characteristics

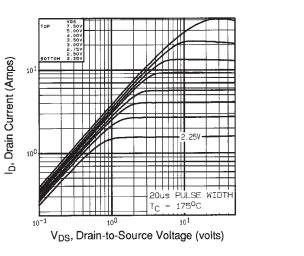


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 175 °C

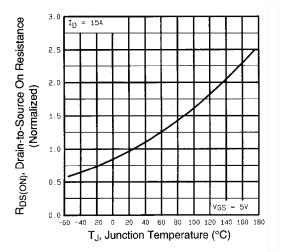


Fig. 4 - Normalized On-Resistance vs. Temperature

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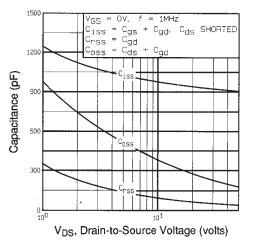


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

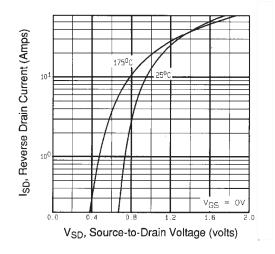


Fig. 7 - Typical Source-Drain Diode Forward Voltage

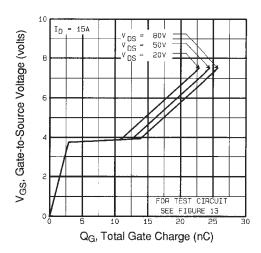


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

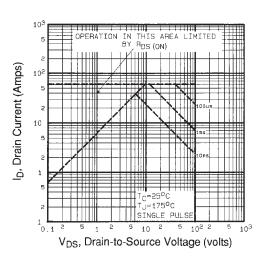


Fig. 8 - Maximum Safe Operating Area

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## IRL530, SiHL530

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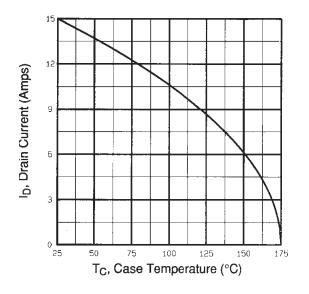


Fig. 9 - Maximum Drain Current vs. Case Temperature

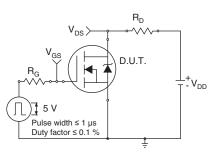


Fig. 10a - Switching Time Test Circuit

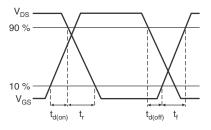


Fig. 10b - Switching Time Waveforms

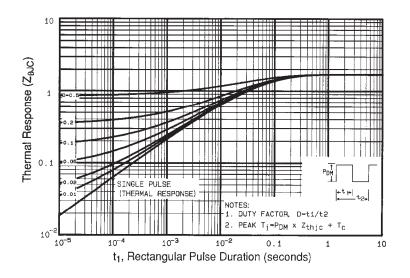


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



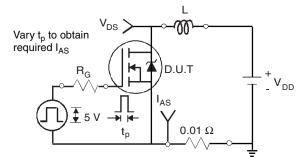


Fig. 12a - Unclamped Inductive Test Circuit

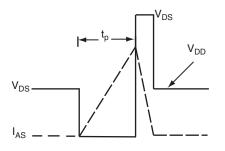


Fig. 12b - Unclamped Inductive Waveforms

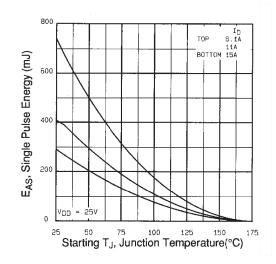


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

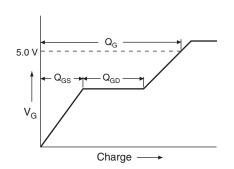


Fig. 13a - Basic Gate Charge Waveform

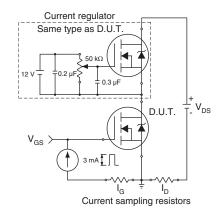
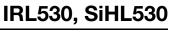


Fig. 13b - Gate Charge Test Circuit

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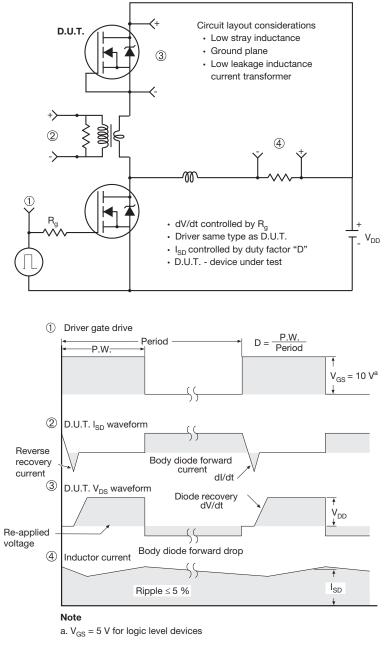


Fig. 14 - For N-Channel

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